

2N AND 2P-CHANNEL Enhancement Mode MOSFET

TDM3411

DESCRIPTION

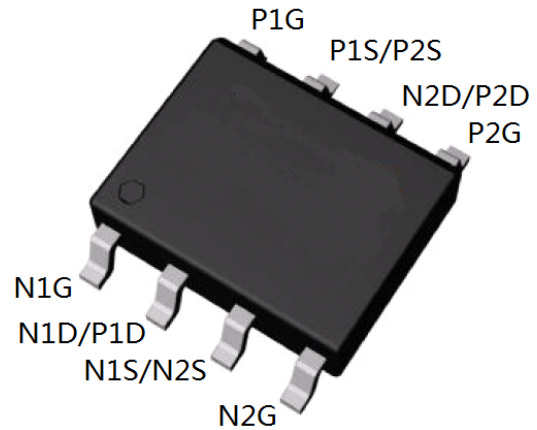
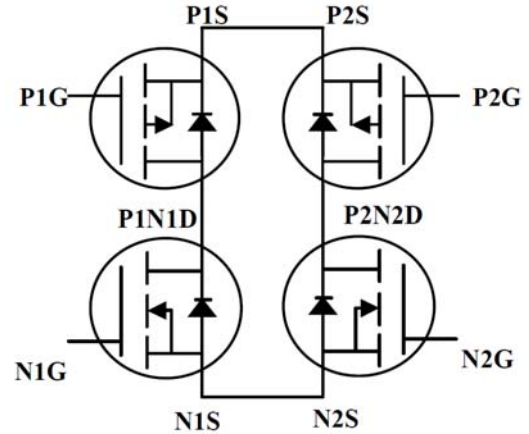
The TDM3411 uses advanced trench technology to provide excellent RDS(ON) and low gate charge. This device is suitable for use as a load switch or in PWM applications.

GENERAL FEATURES

- N CHANNEL
RDS(ON) < 35mΩ @ VGS=4.5V
RDS(ON) < 31mΩ @ VGS=10V
- P CHANNEL
RDS(ON) < 43mΩ @ VGS=-4.5V
RDS(ON) < 33mΩ @ VGS=-10V
- High Power and current handling capability
- Lead free product is available
- SOP-8 Package

Application

- PWM applications
- Load switch
- Power management
- Hard Switched and High Frequency Circuits



ABSOLUTE MAXIMUM RATINGS(TA=25°C unless otherwise noted)

Parameter	Symbol	Limit		Unit
		N-channel	P-channel	
Drain-Source Voltage	V _{DS}	30	-30	V
Gate-Source Voltage	V _{GS}	+20	+20	V
Drain Current @ Continuous	I _D (TA=25°C)	6	-4.5	A
	I _D (TA=70°C)	4.8	-3.6	A
Drain Current @ Current-Pulsed (Note 1)	I _{DM}	22.5	22.5	A
Maximum Power Dissipation (TA=25°C)	P _D	2.0		W
Maximum Operating Junction Temperature	T _J	150		°C
Storage Temperature Range	T _{STG}	-55 To 150		°C

THERMAL CHARACTERISTICS

Thermal Resistance, Junction-to-Ambient (Note 1)	R _{θJA}	90	°C/W
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N-CH ELECTRICAL CHARACTERISTICS ($T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=250\mu A$	30	-	-	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=24V, V_{GS}=0V$	-	-	1	μA
Gate-Body Leakage Current	I_{GSS}	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	± 100	nA
ON CHARACTERISTICS (Note 2)						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	1.3	1.8	2.5	V
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS}=4.5V, I_D=5A$	-	31	35	m Ω
		$V_{GS}=10V, I_D=8A$	-	25	31	m Ω
DYNAMIC CHARACTERISTICS (Note3)						
Input Capacitance	C_{iss}	$V_{DS}=15V, V_{GS}=0V, F=1.0MHz$	300	410	550	PF
Output Capacitance	C_{oss}		40	70	100	PF
Reverse Transfer Capacitance	C_{rss}		30	40	60	PF
SWITCHING CHARACTERISTICS (Note 3)						
Total Gate Charge	Q_g	$V_{DS}=15V, I_D=8A, V_{GS}=4.5V$	-	3.8	5.5	nC
Gate-Source Charge	Q_{gs}		-	1.3	-	nC
Gate-Drain Charge	Q_{gd}		-	1.6	-	nC
DRAIN-SOURCE DIODE CHARACTERISTICS						
Diode Forward Voltage (Note 2)	V_{SD}	$V_{GS}=0V, I_S=5A$	-	0.8	1.3	V

NOTES:

1. Pulse width limited by max. junction temperature.
2. Pulse Test: Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$.
3. Guaranteed by design, not subject to production testing

P-CH ELECTRICAL CHARACTERISTICS ($T_A=25^{\circ}\text{C}$ unless otherwise noted)

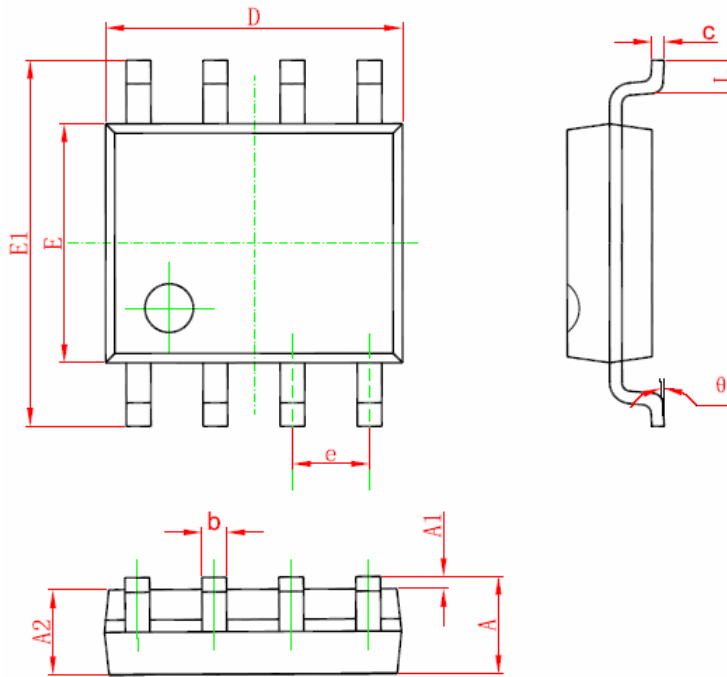
Parameter	Symbol	Condition	Min	Typ	Max	Unit
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=-250\mu A$	-30	-	-	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=-24V, V_{GS}=0V$	-	-	-1	μA
Gate-Body Leakage Current	I_{GSS}	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	± 100	nA
ON CHARACTERISTICS (Note 2)						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	-1.3	-1.8	-2.3	V
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS}=-4.5V, I_D=-4A$	-	39	43	$m\Omega$
		$V_{GS}=-10V, I_D=9.3A$	-	29	33	$m\Omega$
DYNAMIC CHARACTERISTICS (Note3)						
Input Capacitance	C_{iss}	$V_{DS}=-15V, V_{GS}=0V, F=1.0MHz$	-	840	-	PF
Output Capacitance	C_{oss}		-	150	-	PF
Reverse Transfer Capacitance	C_{rss}		-	110	-	PF
SWITCHING CHARACTERISTICS (Note 3)						
Total Gate Charge	Q_g	$V_{DS}=-15V, I_D=-9.3A, V_{GS}=-10V$	-	18	-	nC
Gate-Source Charge	Q_{gs}		-	3	-	nC
Gate-Drain Charge	Q_{gd}		-	4	-	nC
DRAIN-SOURCE DIODE CHARACTERISTICS						
Diode Forward Voltage (Note 2)	V_{SD}	$V_{GS}=0V, I_S=-2A$	-	-0.8	-1.1	V

NOTES:

1. Pulse width limited by max. junction temperature.
2. Pulse Test: Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$.
3. Guaranteed by design, not subject to production testing

Package Information

SOP-8 Package



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270 (BSC)		0.050 (BSC)	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

Design Notes